

FGL35N120FTD 1200 V, 35 A Field Stop Trench IGBT

Features

- Field Stop Trench Technology
- High Speed Switching
- Low Saturation Voltage: V_{CE(sat)} = 1.68 V @ I_C = 35 A
- High Input Impedance

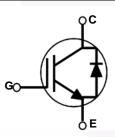
Applications

• Solar Inverter, UPS, Welder, PFC

General Description

Using advanced field stop trench IGBT technology, Fairchild's 1200V trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder applications.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		1200	V	
V _{GES}	Gate to Emitter Voltage		± 25	V	
	Collector Current	@ T _C = 25°C	70	А	
IC C	Collector Current	@ T _C = 100 ^o C	35	A	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	105	A	
I _F	Diode Continuous Forward Current	@ T _C = 25 ^o C	80	A	
	Diode Continuous Forward Current	@ T _C = 100 ^o C	40	A	
P _D	Maximum Power Dissipation	@ T _C = 25°C	368	W	
D	Maximum Power Dissipation	@ T _C = 100 ^o C	147	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 second	ls	300	°C	

Notes: 1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Max.	Unit	
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	0.34	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	0.9	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	25	°C/W	

Part NumberTop MarkPackageFGL35N120FTDTUFGL35N120FTDTO-264		Packag	je	Packing Method	Reel Size		Tape Width		Quantity	
		4 Tube		N/A		N/A		30		
Electric	al Cha	racteristics o	of the IC	GB.	$T_{C} = 25^{\circ}C$ unless otherwise	noted				
Symbol		Parameter			Test Conditions		Min.	Тур.	Max	. Uni
Off Charac	teristics									
BV _{CES}		r to Emitter Breakdow	n Voltage	VG	_Ξ = 0 V, I _C = 250 μA		1200	-	-	V
ICES		r Cut-Off Current			$V_{CES}, V_{GE} = 0 V$		-	-	1	mA
I _{GES}	G-E Lea	kage Current		$V_{GE} = V_{GES}, V_{CE} = 0 V$			-	-	±250) nA
010		0								
On Charac	teristics									
V _{GE(th)}	G-E Thr	eshold Voltage		I _C =	= 35 mA, V _{CE} = V _{GE}		3.5	6.2	7.5	V
					: 35 A, V _{GE} = 15 V		-	1.68	2.2	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage		$I_{C} = 35 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$				2.0	-	V	
Dynamic C	haracter	stics		1						
C _{ies}		pacitance					-	5090	-	pF
C _{oes}	Output 0	Capacitance		$V_{CE} = 30 V, V_{GE} = 0 V,$		-	-	180	-	pF
C _{res}	Reverse	e Transfer Capacitance		f = 1 MHz			-	95	-	pF
Switching	Characte	ristics		1		I				
t _{d(on)}		Delay Time					-	34	-	ns
t _r	Rise Tin	ne					-	63	-	ns
t _{d(off)}	Turn-Off	Delay Time		Va	_C = 600 V, I _C = 35 A,		-	172	-	ns
t _f	Fall Tim	8		R_{G}	= 10 Ω, V _{GE} = 15 V,		-	107	-	ns
E _{on}	Turn-On	Switching Loss		Ind	uctive Load, $T_C = 25^{\circ}C$		-	2.5	-	mJ
E _{off}	Turn-Off	Switching Loss		İ		F	-	1.7	-	mJ
E _{ts}		ritching Loss				F	-	4.2	-	mJ
t _{d(on)}	Turn-On	Delay Time						33	-	ns
t _r	Rise Tin			İ		F		66	-	ns
t _{d(off)}	Turn-Off	Delay Time		Vc	_C = 600 V, I _C = 35 A,			180	-	ns
t _f	Fall Tim	e		R_{G}	= 10 Ω, V _{GE} = 15 V,		-	146	-	ns
E _{on}	Turn-On	Switching Loss		Inductive Load, $T_C = 125^{\circ}C$			-	3.1	-	mJ
E _{off}	Turn-Off	Switching Loss					-	2.1	-	mJ
E _{ts}	Total Sw	ritching Loss				F	-	5.2	-	mJ
Qg	Total Ga	te Charge					-	210	-	nC
Q _{ge}		Emitter Charge			$= 600 \text{ V}, \text{ I}_{\text{C}} = 35 \text{ A},$	-	-	42	-	nC
Q _{gc}		Collector Charge		VGI	V _{GE} = 15 V		-	101	-	nC

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FGL35N120FTD
— 1200 V,
V, 35 A Field
A Field Stop Tre
rench IGBT

Symbol	Parameter	Test Condition	Min.	Тур.	Max	Unit	
V _{FM} Diode Forward Voltage	Diode Forward Voltage	I _F = 35 A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	2.7	3.4	V
	·F 007.	T _C = 125°C	-	2.5	-] ்	
t _{rr}	r Diode Reverse Recovery Time		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	337	-	ns A
-11			$T_{C} = 125^{\circ}C$	-	520	-	
I _{rr}	Diode Peak Reverse Recovery Current	I _F = 35 A, di _F /dt = 200 A/μs	$T_{C} = 25^{\circ}C$	-	7.6	-	
		di _F /dt = 200 A/µs	$T_{C} = 125^{\circ}C$	-	12.9	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	-	1292	-	nC
∽rr	Diede Hereice Heedvery enarge		$T_{\rm C} = 125^{\rm o}{\rm C}$	-	3377	-	

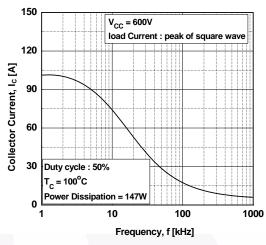
Typical Performance Characteristics Figure 1. Typical Output Characteristics Figure 2. Typical Output Characteristics 180 180 $T_C = 25^{\circ}C$ T_C = 125^oC 17V 17V 20V 20\ 15V 15V 150 150 12V 12V Collector Current, I_c [A] Collector Current, I_c [A] 120 120 90 90 10V 10V 60 60 9V 9V 30 30 V_{GE} = 8V V_{GE} = 8V 0 0 2 4 6 Collector-Emitter Voltage, V_{CE} [V] 2 4 6 Collector-Emitter Voltage, V_{CE} [V] 0 8 8 0 Figure 3. Typical Saturation Voltage **Figure 4. Transfer Characteristics Characteristics** 120 120 Common Emitter Common Emitter $V_{CE} = 20V$ $V_{GE} = 15V$ 100 100 $T_C = 25^{\circ}C$ $T_{C} = 25^{\circ}C$ — Collector Current, I_c [A] Collector Current, I_c [A] T_C = 125^oC T_C = 125^oC ... 80 80 60 60 40 40 20 20 0 0 0 1 2 3 8 10 12 4 4 6 Collector-Emitter Voltage, V_{CE} [V] Gate-Emitter Voltage, VGE [V] Figure 6. Saturation Voltage vs. V_{GE} Figure 5. Saturation Voltage vs. Case **Temperature at Variant Current Level** 2.8 20 Common Emitter Common Emitter 70A V_{GE} = 15V $T_{C} = 25^{\circ}C$ Collector-Emitter Voltage, V_{CE} [V] 2.6 Collector-Emitter Voltage, V cE [V] 16 2.4 2.2 12 2.0 35A 8 1.8 70Å 35A 1.6 I_C = 18A 4 1.4 I_C = 18A 0 ∟ 4 1.2 50 75 100 125 20 25 8 12 16 Case Temperature, T_C [°C] Gate-Emitter Voltage, VGE [V]

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Figure 7. Saturation Voltage vs. V_{GE} 20 Common Emitter $T_C = 125^{\circ}C$ \geq 16 Collector-Emitter Voltage, V_{CE} Collector Current, I_c [A] 12 8 70A 35A 4 $I_{\rm C} = 18A$ 0 8 20 4 12 16 Gate-Emitter Voltage, V_{GE} [V] **Figure 9. Capacitance Characteristics** 8000 Common Emitter V_{GE} = 0V, f = 1MHz Cies T_C = 25°C 6000 Capacitance [pF] 4000 C_{oes} 2000 Cres 0 1 10 30 Collector-Emitter Voltage, V_{CE} [V] Figure 11. SOA Characteristics 400 100 10µs Collector Current, Ic [A] 10 100µs Ims 1 10 ms DC *Notes: 0.1 1. $T_{C} = 25^{\circ}C$ 2. $T_J = 150^{\circ}C$

Typical Performance Characteristics

Figure 8. Load Current vs. Frequency





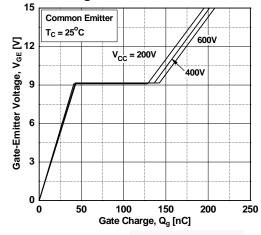
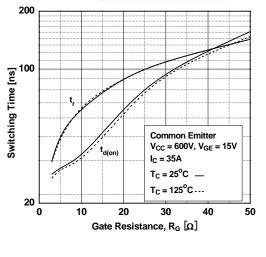


Figure 12. Turn-on Characteristics vs. Gate Resistance



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0.01

1

3. Single Pulse

10

100

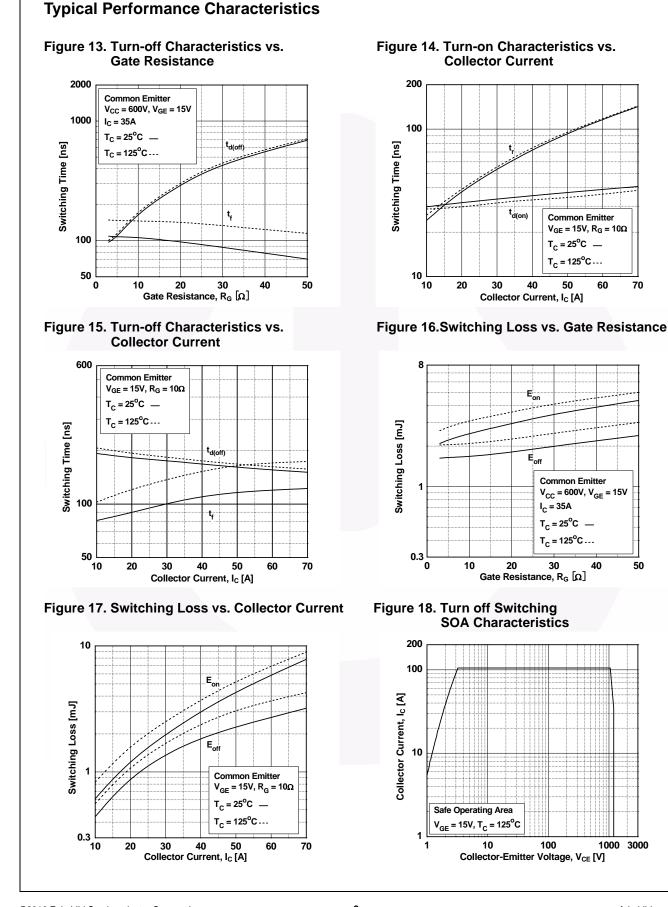
Collector-Emitter Voltage, V_{CE} [V]

1000

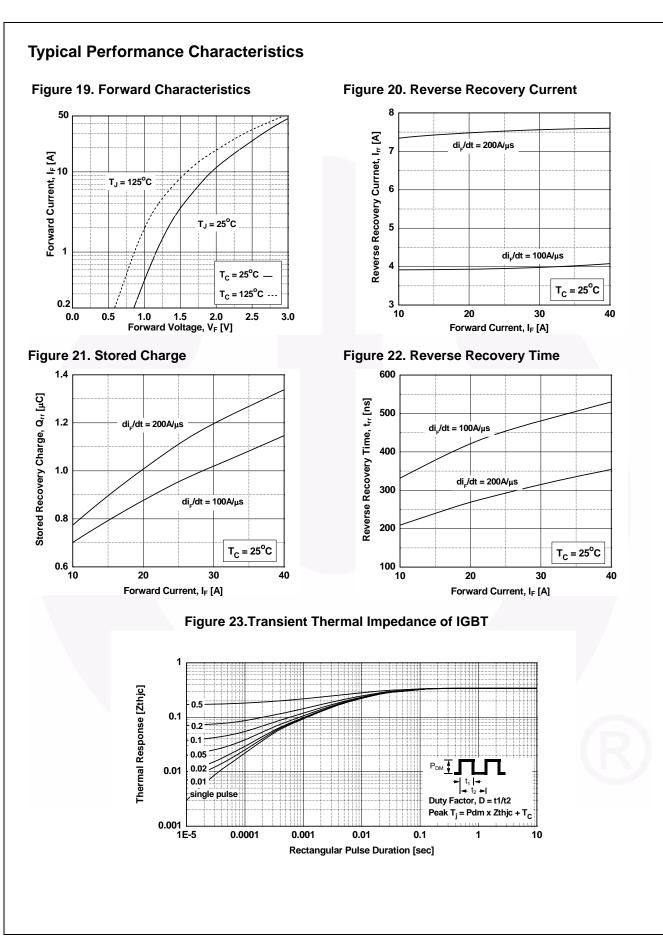
4000

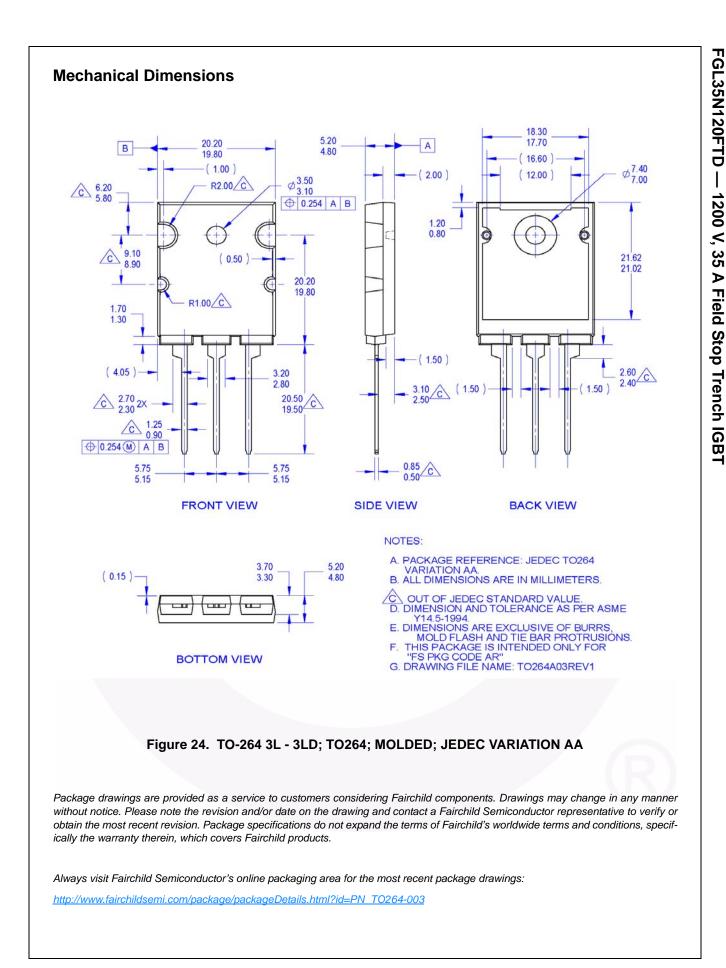
70

50



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